

CBR08C639BCGAC

CBR-SMD RF COG, Ceramic, 6.3 pF, +/-0.1 pF, 500 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0805



Click here for the 3D model.

Dimensions		
Chip Size	0805	
L	2mm +/-0.2mm	
W	1.25mm +/-0.2mm	
Т	0.85mm +/-0.1mm	
В	0.5mm +/-0.2mm	

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	4000

General Information	
Series	CBR-SMD RF COG
Style	SMD Chip
Description	SMD, Fixed, RF, Ultra High Q, Low ESR, Class I
Features	Ultra High Q, Low ESR, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Component Weight	10.7 mg
Notes	Solder Wave or Solder Reflow.
Shelf Life	78 Weeks
MSL	1

Specifications	/
Capacitance	6.3 pF
Capacitance Tolerance	+/-0.1pF
Voltage DC	500 VDC
Dielectric Withstanding Voltage	750 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	COG
Dissipation Factor	0.19%
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	10 GOhms
Quality Factor	526

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